## 1-1775333-4 × OBSOLETE

#### FPC

TE Internal #: 1-1775333-4

TE Internal Description: ZIF FPC 0.5, 2H, 14P

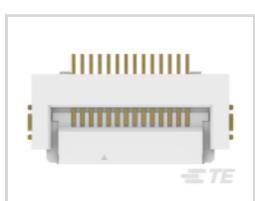
View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > FPC Connectors











Centerline (Pitch): .5 mm [ .02 in ]
PCB Mount Orientation: Right Angle

Contact Mating Location: **Bottom** 

Termination Method to PCB: Surface Mount

FPC Actuator Type: Front Flip-Lock

#### **Features**

## **Product Type Features**

| PCB Connector Type                | PCB Mount Receptacle           |
|-----------------------------------|--------------------------------|
| Connector & Contact Terminates To | Flexible Printed Circuit (FPC) |
| Connector Product Type            | Connector Assembly             |
| Connector System                  | Flex-to-Board                  |
| FPC Actuator Type                 | Front Flip-Lock                |

## **Configuration Features**

| Compatible With Wire & Cable Type | FFC, FPC    |
|-----------------------------------|-------------|
| Number of Rows                    | 1           |
| PCB Mount Orientation             | Right Angle |
| Number of Positions               | 14          |
|                                   |             |

#### **Electrical Characteristics**

| Operating Voltage | 250 VAC |  |
|-------------------|---------|--|
|-------------------|---------|--|

#### **Body Features**

| Primary Product Color Natural |  |
|-------------------------------|--|
|-------------------------------|--|

## **Contact Features**



| Contact Current Rating (Max)                            | .5 A                         |
|---------------------------------------------------------|------------------------------|
| Contact Shape & Form                                    | Single Beam                  |
| PCB Contact Termination Area Plating Material Thickness | .025 μm[1 μin]               |
| Contact Layout                                          | Inline                       |
| Contact Base Material                                   | Phosphor Bronze              |
| PCB Contact Termination Area Plating Material           | Gold                         |
| Contact Type                                            | Socket                       |
| Contact Mating Area Plating Material Thickness          | .025 μm[1 μin]               |
| Contact Mating Location                                 | Bottom                       |
| Contact Mating Area Plating Material                    | Gold (Au)                    |
| Termination Features                                    |                              |
| Termination Method to PCB                               | Surface Mount                |
| Mechanical Attachment                                   |                              |
| Connector Mounting Type                                 | Board Mount                  |
| Mating Alignment                                        | With                         |
| PCB Mount Alignment                                     | Without                      |
| PCB Mount Retention                                     | With                         |
| Housing Features                                        |                              |
| Housing Material                                        | LCP (Liquid Crystal Polymer) |
| Centerline (Pitch)                                      | .5 mm[.02 in]                |
| Dimensions                                              |                              |
| Connector Width                                         | 6.25 mm[.246 in]             |
| Accepts Flex Cable Thickness                            | .3 mm[.012 in]               |
| Connector Height                                        | 2 mm[.079 in]                |
| Connector Length                                        | 11.75 mm[.463 in]            |
| Operation/Application                                   |                              |
| Circuit Application                                     | Signal                       |
| Identification Marking                                  |                              |
| Circuit Identification Feature                          | With                         |
| Packaging Features                                      |                              |
| Packaging Method                                        | Tape & Reel                  |
| Packaging Quantity                                      | 2000                         |



#### **Product Compliance**

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU                  | Compliant                                                                                                                           |
|-----------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|
| EU ELV Directive 2000/53/EC                   | Compliant                                                                                                                           |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold                                                                                             |
| EU REACH Regulation (EC) No. 1907/2006        | Current ECHA Candidate List: JAN 2025<br>(247)<br>Candidate List Declared Against: JAN 2023<br>(233)<br>Does not contain REACH SVHC |
| Halogen Content                               | Not Low Halogen - contains Br or Cl > 900 ppm.                                                                                      |
| Solder Process Capability                     | Reflow solder capable to 260°C                                                                                                      |

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Customers Also Bought



TE Part #1745096-1 AMP SUPERSEAL 1,5 SRS. 2 POS. PLUG ASS'Y



TE Part #2327679-1 RECEPTACLE ASSY, 56 POS, VERT, GEN Z



TE Part #9-1734774-3
PCI EXP 2.3L 64 POS BLK 30u"



TE Part #2169806-1 IMP,Power,3PR,Vert,Recp,Tin















#### **Documents**

#### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_1-1775333-4\_F.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1-1775333-4\_F.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1-1775333-4\_F.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

## **Product Specifications**

ZIF 0.5mm Pitch FPC, SMT Connector

English